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Intel - EPF8452AQC160-2 Datasheet



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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	42
Number of Logic Elements/Cells	336
Total RAM Bits	
Number of I/O	120
Number of Gates	4000
Voltage - Supply	4.75V ~ 5.25V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 70°C (TA)
Package / Case	160-BQFP
Supplier Device Package	160-PQFP (28x28)
Purchase URL	https://www.e-xfl.com/product-detail/intel/epf8452aqc160-2

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Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

JTAG BST circuitry	Yes	No	Yes	Yes	No	Yes

...and More Features

Peripheral register for fast setup and clock-to-output delay
 Fabricated on an educated CDAM succession

- Fabricated on an advanced SRAM process
 - Available in a variety of packages with 84 to 304 pins (see Table 2)
 Software design support and automatic place-and-route provided by the Altera[®] MAX+PLUS[®] II development system for Windows-based PCs, as well as Sun SPARCstation, HP 9000 Series 700/800, and IBM RISC System/6000 workstations
 - Additional design entry and simulation support provided by EDIF 2 0 0 and 3 0 0 netlist files, library of parameterized modules (LPM), Verilog HDL, VHDL, and other interfaces to popular EDA tools from manufacturers such as Cadence, Exemplar Logic, Mentor Graphics, OrCAD, Synopsys, Synplicity, and Veribest

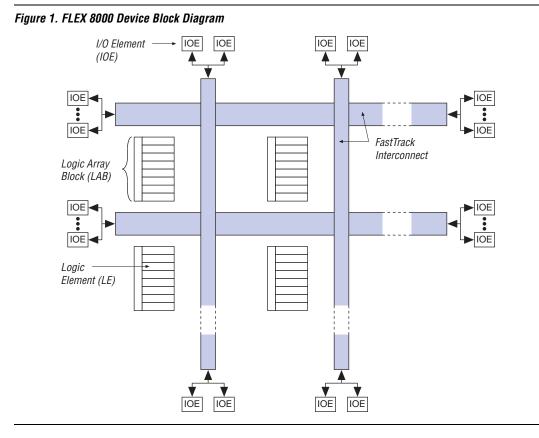
Table 2. FLE	X 8000 F	Package	Options	& I/O Pil	n Count	Not	e (1)					
Device	84- Pin PLCC	100- Pin TQFP	144- Pin TQFP	160- Pin PQFP	160- Pin PGA	192- Pin PGA	208- Pin PQFP	225- Pin BGA	232- Pin PGA	240- Pin PQFP	280- Pin PGA	304- Pin RQFP
EPF8282A	68	78										
EPF8282AV		78										
EPF8452A	68	68		120	120							
EPF8636A	68			118		136	136					
EPF8820A			112	120		152	152	152				
EPF81188A							148		184	184		
EPF81500A										181	208	208

Note:

(1) FLEX 8000 device package types include plastic J-lead chip carrier (PLCC), thin quad flat pack (TQFP), plastic quad flat pack (PQFP), power quad flat pack (RQFP), ball-grid array (BGA), and pin-grid array (PGA) packages.

General Description

Altera's Flexible Logic Element MatriX (FLEX[®]) family combines the benefits of both erasable programmable logic devices (EPLDs) and fieldprogrammable gate arrays (FPGAs). The FLEX 8000 device family is ideal for a variety of applications because it combines the fine-grained architecture and high register count characteristics of FPGAs with the high speed and predictable interconnect delays of EPLDs. Logic is implemented in LEs that include compact 4-input look-up tables (LUTs) and programmable registers. High performance is provided by a fast, continuous network of routing resources. Figure 1 shows a block diagram of the FLEX 8000 architecture. Each group of eight LEs is combined into an LAB; LABs are arranged into rows and columns. The I/O pins are supported by I/O elements (IOEs) located at the ends of rows and columns. Each IOE contains a bidirectional I/O buffer and a flipflop that can be used as either an input or output register.

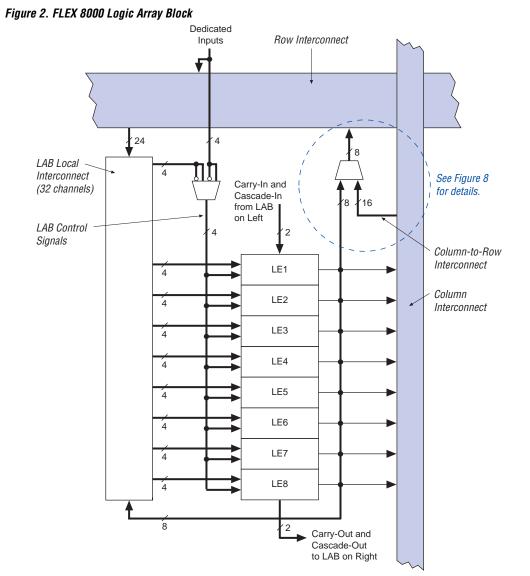


Signal interconnections within FLEX 8000 devices and between device pins are provided by the FastTrack Interconnect, a series of fast, continuous channels that run the entire length and width of the device. IOEs are located at the end of each row (horizontal) and column (vertical) FastTrack Interconnect path.

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Logic Array Block

A logic array block (LAB) consists of eight LEs, their associated carry and cascade chains, LAB control signals, and the LAB local interconnect. The LAB provides the coarse-grained structure of the FLEX 8000 architecture. This structure enables FLEX 8000 devices to provide efficient routing, high device utilization, and high performance. Figure 2 shows a block diagram of the FLEX 8000 LAB.



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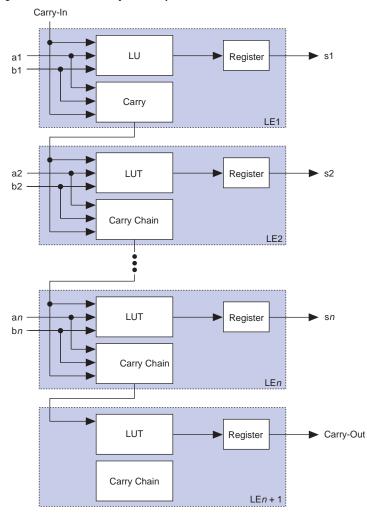


Figure 4. FLEX 8000 Carry Chain Operation

Cascade Chain

With the cascade chain, the FLEX 8000 architecture can implement functions that have a very wide fan-in. Adjacent LUTs can be used to compute portions of the function in parallel; the cascade chain serially connects the intermediate values. The cascade chain can use a logical AND or logical OR (via De Morgan's inversion) to connect the outputs of adjacent LEs. Each additional LE provides four more inputs to the effective width of a function, with a delay as low as 0.6 ns per LE.

The MAX+PLUS II Compiler can create cascade chains automatically during design processing; designers can also insert cascade chain logic manually during design entry. Cascade chains longer than eight LEs are automatically implemented by linking LABs together. The last LE of an LAB cascades to the first LE of the next LAB.

Figure 5 shows how the cascade function can connect adjacent LEs to form functions with a wide fan-in. These examples show functions of 4n variables implemented with n LEs. For a device with an A-2 speed grade, the LE delay is 2.4 ns; the cascade chain delay is 0.6 ns. With the cascade chain, 4.2 ns is needed to decode a 16-bit address.

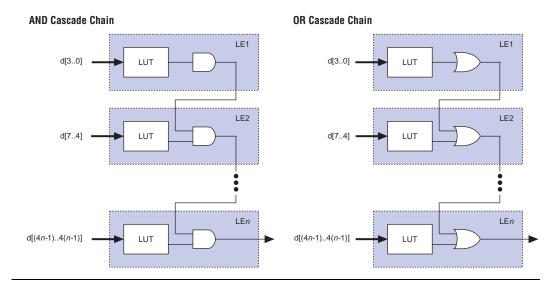
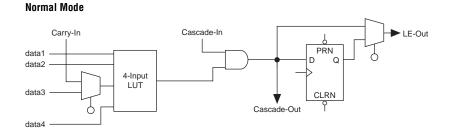


Figure 5. FLEX 8000 Cascade Chain Operation

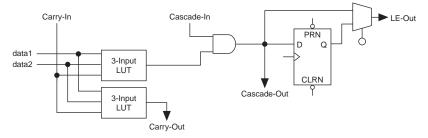
LE Operating Modes

The FLEX 8000 LE can operate in one of four modes, each of which uses LE resources differently. See Figure 6. In each mode, seven of the ten available inputs to the LE—the four data inputs from the LAB local interconnect, the feedback from the programmable register, and the carry-in and cascade-in from the previous LE—are directed to different destinations to implement the desired logic function. The three remaining inputs to the LE provide clock, clear, and preset control for the register. The MAX+PLUS II software automatically chooses the appropriate mode for each application. Design performance can also be enhanced by designing for the operating mode that supports the desired application.

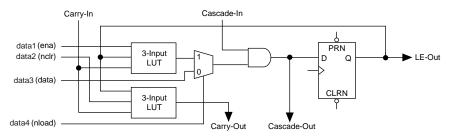
Figure 6. FLEX 8000 LE Operating Modes



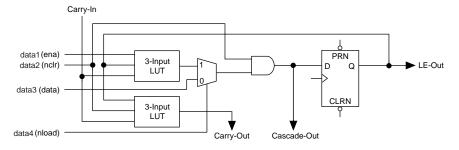
Arithmetic Mode



Up/Down Counter Mode



Clearable Counter Mode



Asynchronous Clear

A register is cleared by one of the two LABCTRL signals. When the CLRn port receives a low signal, the register is set to zero.

Asynchronous Preset

An asynchronous preset is implemented as either an asynchronous load or an asynchronous clear. If DATA3 is tied to VCC, asserting LABCTRL1 asynchronously loads a 1 into the register. Alternatively, the MAX+PLUS II software can provide preset control by using the clear and inverting the input and output of the register. Inversion control is available for the inputs to both LEs and IOEs. Therefore, if a register is preset by only one of the two LABCTRL signals, the DATA3 input is not needed and can be used for one of the LE operating modes.

Asynchronous Clear & Preset

When implementing asynchronous clear and preset, LABCTRL1 controls the preset and LABCTRL2 controls the clear. The DATA3 input is tied to VCC; therefore, asserting LABCTRL1 asynchronously loads a 1 into the register, effectively presetting the register. Asserting LABCTRL2 clears the register.

Asynchronous Load with Clear

When implementing an asynchronous load with the clear, LABCTRL1 implements the asynchronous load of DATA3 by controlling the register preset and clear. LABCTRL2 implements the clear by controlling the register clear.

Asynchronous Load with Preset

When implementing an asynchronous load in conjunction with a preset, the MAX+PLUS II software provides preset control by using the clear and inverting the input and output of the register. Asserting LABCTRL2 clears the register, while asserting LABCTRL1 loads the register. The MAX+PLUS II software inverts the signal that drives the DATA3 signal to account for the inversion of the register's output.

Asynchronous Load without Clear or Preset

When implementing an asynchronous load without the clear or preset, LABCTRL1 implements the asynchronous load of DATA3 by controlling the register preset and clear.

Each LE in an LAB can drive up to two separate column interconnect channels. Therefore, all 16 available column channels can be driven by the LAB. The column channels run vertically across the entire device, and share access to LABs in the same column but in different rows. The MAX+PLUS II Compiler chooses which LEs must be connected to a column channel. A row interconnect channel can be fed by the output of the LE or by two column channels. These three signals feed a multiplexer that connects to a specific row channel. Each LE is connected to one 3-to-1 multiplexer. In an LAB, the multiplexers provide all 16 column channels with access to 8 row channels.

Each column of LABs has a dedicated column interconnect that routes signals out of the LABs into the column. The column interconnect can then drive I/O pins or feed into the row interconnect to route the signals to other LABs in the device. A signal from the column interconnect, which can be either the output of an LE or an input from an I/O pin, must transfer to the row interconnect before it can enter an LAB. Table 4 summarizes the FastTrack Interconnect resources available in each FLEX 8000 device.

Table 4. FLE	EX 8000 Fa	astTrack Interconnec	t Resources	
Device	Rows	Channels per Row	Columns	Channels per Column
EPF8282A EPF8282AV	2	168	13	16
EPF8452A	2	168	21	16
EPF8636A	3	168	21	16
EPF8820A	4	168	21	16
EPF81188A	6	168	21	16
EPF81500A	6	216	27	16

Figure 9 shows the interconnection of four adjacent LABs, with row, column, and local interconnects, as well as the associated cascade and carry chains.

The instruction register length for FLEX 8000 devices is three bits. Table 7 shows the boundary-scan register length for FLEX 8000 devices.

Table 7. FLEX 8000 Boundary-Scan	able 7. FLEX 8000 Boundary-Scan Register Length						
Device	Device Boundary-Scan Register Length						
EPF8282A, EPF8282AV	273						
EPF8636A	417						
EPF8820A	465						
EPF81500A	645						

FLEX 8000 devices that support JTAG include weak pull-ups on the JTAG pins. Figure 14 shows the timing requirements for the JTAG signals.

Figure 14. EPF8282A, EPF8282AV, EPF8636A, EPF8820A & EPF81500A JTAG Waveforms

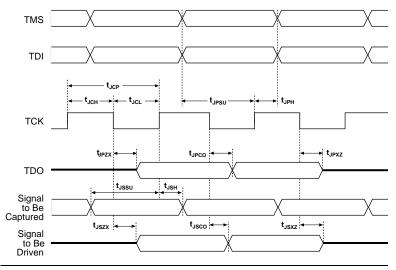


Table 8 shows the timing parameters and values for EPF8282A, EPF8282AV, EPF8636A, EPF8820A, and EPF81500A devices.

Symbol			Speed	Grade			Unit
	A	-2	A	-3	A		
	Min	Max	Min	Мах	Min	Мах	
t _{LUT}		2.0		2.5		3.2	ns
t _{CLUT}		0.0		0.0		0.0	ns
t _{RLUT}		0.9		1.1		1.5	ns
t _{GATE}		0.0		0.0		0.0	ns
t _{CASC}		0.6		0.7		0.9	ns
t _{CICO}		0.4		0.5		0.6	ns
t _{CGEN}		0.4		0.5		0.7	ns
t _{CGENR}		0.9		1.1		1.5	ns
t _C		1.6		2.0		2.5	ns
t _{CH}	4.0		4.0		4.0		ns
t _{CL}	4.0		4.0		4.0		ns
t _{CO}		0.4		0.5		0.6	ns
t _{COMB}		0.4		0.5		0.6	ns
t _{SU}	0.8		1.1		1.2		ns
t _H	0.9		1.1		1.5		ns
t _{PRE}		0.6		0.7		0.8	ns
t _{CLR}		0.6		0.7		0.8	ns

Table 25. EPF8282A External Timing Parameters

Symbol			Speed Grade				
	A	A-2		-3	A-		
	Min	Max	Min	Max	Min	Мах	
t _{DRR}		15.8		19.8		24.8	ns
t _{ODH}	1.0		1.0		1.0		ns

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Symbol	Speed Grade							
	A	-3	A	A-4				
ł	Min	Max	Min	Max				
t _{LUT}		3.2		7.3	ns			
t _{CLUT}		0.0		1.4	ns			
t _{RLUT}		1.5		5.1	ns			
t _{GATE}		0.0		0.0	ns			
t _{CASC}		0.9		2.8	ns			
t _{CICO}		0.6		1.5	ns			
t _{CGEN}		0.7		2.2	ns			
t _{CGENR}		1.5		3.7	ns			
t _C		2.5		4.7	ns			
t _{CH}	4.0		6.0		ns			
t _{CL}	4.0		6.0		ns			
t _{CO}		0.6		0.9	ns			
t _{COMB}		0.6		0.9	ns			
t _{SU}	1.2		2.4		ns			
t _H	1.5		4.6		ns			
t _{PRE}		0.8		1.3	ns			
t _{CLR}		0.8		1.3	ns			

Table 29. EP	Table 29. EPF8282AV External Timing Parameters									
Symbol		Unit								
	A	-3	A	A-4						
	Min	Max	Min	Max						
t _{DRR}		24.8		50.1	ns					
t _{ODH}	1.0		1.0		ns					

Symbol			Speed (Grade			Unit
	A	A-2		-3	A-4		
	Min	Max	Min	Max	Min	Max	
t _{IOD}		0.7		0.8		0.9	ns
t _{IOC}		1.7		1.8		1.9	ns
t _{IOE}		1.7		1.8		1.9	ns
t _{IOCO}		1.0		1.0		1.0	ns
t _{IOCOMB}		0.3		0.2		0.1	ns
t _{IOSU}	1.4		1.6		1.8		ns
t _{IOH}	0.0		0.0		0.0		ns
t _{IOCLR}		1.2		1.2		1.2	ns
t _{IN}		1.5		1.6		1.7	ns
t _{OD1}		1.1		1.4		1.7	ns
t _{OD2}		1.6		1.9		2.2	ns
t _{OD3}		4.6		4.9		5.2	ns
t _{XZ}		1.4		1.6		1.8	ns
t _{ZX1}		1.4		1.6		1.8	ns
t _{ZX2}		1.9		2.1		2.3	ns
t _{ZX3}		4.9		5.1		5.3	ns

Symbol		Speed Grade								
	A-2		A-3		A-4		1			
	Min	Max	Min	Max	Min	Max	1			
t _{LABCASC}		0.3		0.4		0.4	ns			
t _{LABCARRY}		0.3		0.4		0.4	ns			
t _{LOCAL}		0.5		0.5		0.7	ns			
t _{ROW}		5.0		5.0		5.0	ns			
t _{COL}		3.0		3.0		3.0	ns			
t _{DIN_C}		5.0		5.0		5.5	ns			
t _{DIN_D}		7.0		7.0		7.5	ns			
t _{DIN_IO}		5.0		5.0		5.5	ns			

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Symbol			Speed	Grade			Unit
	A	-2	A	-3	A		
	Min	Max	Min	Max	Min	Max	
t _{IOD}		0.7		0.8		0.9	ns
t _{IOC}		1.7		1.8		1.9	ns
t _{IOE}		1.7		1.8		1.9	ns
t _{IOCO}		1.0		1.0		1.0	ns
t _{IOCOMB}		0.3		0.2		0.1	ns
t _{IOSU}	1.4		1.6		1.8		ns
t _{IOH}	0.0		0.0		0.0		ns
t _{IOCLR}		1.2		1.2		1.2	ns
t _{IN}		1.5		1.6		1.7	ns
t _{OD1}		1.1		1.4		1.7	ns
t _{OD2}		1.6		1.9		2.2	ns
t _{OD3}		4.6		4.9		5.2	ns
t _{XZ}		1.4		1.6		1.8	ns
t _{ZX1}		1.4		1.6		1.8	ns
t _{ZX2}		1.9		2.1		2.3	ns
t _{ZX3}		4.9		5.1		5.3	ns

Symbol		Speed Grade							
	A-2		A-3		A-4		1		
	Min	Max	Min	Max	Min	Max	1		
t _{LABCASC}		0.3		0.3		0.4	ns		
t _{LABCARRY}		0.3		0.3		0.4	ns		
t _{LOCAL}		0.5		0.6		0.8	ns		
t _{ROW}		5.0		5.0		5.0	ns		
t _{COL}		3.0		3.0		3.0	ns		
t _{DIN_C}		5.0		5.0		5.5	ns		
t _{DIN_D}		7.0		7.0		7.5	ns		
t _{DIN IO}		5.0		5.0		5.5	ns		

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Symbol	Speed Grade								
	A-2		A-3		A-4				
	Min	Max	Min	Max	Min	Max	_		
t _{IOD}		0.7		0.8		0.9	ns		
t _{IOC}		1.7		1.8		1.9	ns		
t _{IOE}		1.7		1.8		1.9	ns		
t _{IOCO}		1.0		1.0		1.0	ns		
t _{IOCOMB}		0.3		0.2		0.1	ns		
t _{IOSU}	1.4		1.6		1.8		ns		
t _{IOH}	0.0		0.0		0.0		ns		
t _{IOCLR}		1.2		1.2		1.2	ns		
t _{IN}		1.5		1.6		1.7	ns		
t _{OD1}		1.1		1.4		1.7	ns		
t _{OD2}		1.6		1.9		2.2	ns		
t _{OD3}		4.6		4.9		5.2	ns		
t _{XZ}		1.4		1.6		1.8	ns		
t _{ZX1}		1.4		1.6		1.8	ns		
t _{ZX2}		1.9		2.1		2.3	ns		
t _{ZX3}		4.9		5.1		5.3	ns		

Symbol			Speed	Grade			Unit
	A-2		A-3		A-4		1
	Min	Max	Min	Max	Min	Max	-
t _{LABCASC}		0.3		0.3		0.4	ns
t _{LABCARRY}		0.3		0.3		0.4	ns
t _{LOCAL}		0.5		0.6		0.8	ns
t _{ROW}		6.2		6.2		6.2	ns
t _{COL}		3.0		3.0		3.0	ns
t _{DIN_C}		5.0		5.0		5.5	ns
t _{DIN_D}		8.2		8.2		8.7	ns
t _{DIN_IO}		5.0		5.0		5.5	ns

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Power Consumption

The supply power (P) for FLEX 8000 devices can be calculated with the following equation:

 $P = P_{INT} + P_{IO} = [(I_{CCSTANDBY} + I_{CCACTIVE}) \times V_{CC}] + P_{IO}$

Typical I_{CCSTANDBY} values are shown as I_{CC0} in Table 11 on page 28 and Table 15 on page 30. The P_{IO} value, which depends on the device output load characteristics and switching frequency, can be calculated using the guidelines given in *Application Note* 74 (*Evaluating Power for Altera Devices*). The I_{CCACTIVE} value depends on the switching frequency and the application logic. This value can be calculated based on the amount of current that each LE typically consumes.

The following equation shows the general formula for calculating $I_{\mbox{\scriptsize CCACTIVE}}$:

$$I_{CCACTIVE} = K \times f_{MAX} \times N \times tog_{LC} \times \frac{\mu A}{MHz \times LE}$$

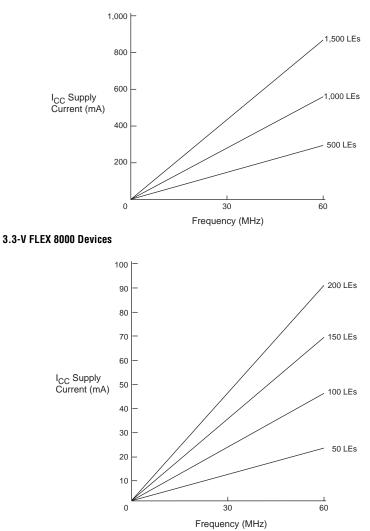
The parameters in this equation are shown below:

f _{MAX}	=	Maximum operating frequency in MHz
Ν	=	Total number of logic cells used in the device
tog _{LC}	=	Average percentage of logic cells toggling at each clock
Κ	=	Constant, shown in Table 50

Table 50. Values for Constant K					
Device	к				
5.0-V FLEX 8000 devices	75				
3.3-V FLEX 8000 devices	60				

This calculation provides an I_{CC} estimate based on typical conditions with no output load. The actual I_{CC} value should be verified during operation because this measurement is sensitive to the actual pattern in the device and the environmental operating conditions.

Figure 20 shows the relationship between $\rm I_{\rm CC}$ and operating frequency for several LE utilization values.





Configuration & Operation



The FLEX 8000 architecture supports several configuration schemes to load a design into the device(s) on the circuit board. This section summarizes the device operating modes and available device configuration schemes.

For more information, go to *Application Note 33* (*Configuring FLEX 8000 Devices*) and *Application Note 38* (*Configuring Multiple FLEX 8000 Devices*).

Altera Corporation

Operating Modes

The FLEX 8000 architecture uses SRAM elements that require configuration data to be loaded whenever the device powers up and begins operation. The process of physically loading the SRAM programming data into the device is called *configuration*. During initialization, which occurs immediately after configuration, the device resets registers, enables I/O pins, and begins to operate as a logic device. The I/O pins are tri-stated during power-up, and before and during configuration. The configuration and initialization processes together are called *command mode*; normal device operation is called *user mode*.

SRAM elements allow FLEX 8000 devices to be reconfigured in-circuit with new programming data that is loaded into the device. Real-time reconfiguration is performed by forcing the device into command mode with a device pin, loading different programming data, reinitializing the device, and resuming user-mode operation. The entire reconfiguration process requires less than 100 ms and can be used to dynamically reconfigure an entire system. In-field upgrades can be performed by distributing new configuration files.

Configuration Schemes

The configuration data for a FLEX 8000 device can be loaded with one of six configuration schemes, chosen on the basis of the target application. Both active and passive schemes are available. In the active configuration schemes, the FLEX 8000 device functions as the controller, directing the loading operation, controlling external configuration devices, and completing the loading process. The clock source for all active configuration schemes is an oscillator on the FLEX 8000 device that operates between 2 MHz and 6 MHz. In the passive configuration schemes, an external controller guides the FLEX 8000 device. Table 51 shows the data source for each of the six configuration schemes.

Table 51. Data Source for Configuration						
Configuration Scheme	Acronym	Data Source				
Active serial	AS	Altera configuration device				
Active parallel up	APU	Parallel configuration device				
Active parallel down	APD	Parallel configuration device				
Passive serial	PS	Serial data path				
Passive parallel synchronous	PPS	Intelligent host				
Passive parallel asynchronous	PPA	Intelligent host				

Pin Name	225-Pin BGA EPF8820A	232-Pin PGA EPF81188A	240-Pin PQFP EPF81188A	240-Pin PQFP EPF81500A	280-Pin PGA EPF81500A	304-Pin RQFP EPF81500A
nSP <i>(2)</i>	A15	C14	237	237	W1	304
MSELO (2)	B14	G15	21	19	N1	26
MSEL1 (2)	R15	L15	40	38	H3	51
nSTATUS (2)	P2	L3	141	142	G19	178
nCONFIG (2)	R1	R4	117	120	B18	152
DCLK (2)	B2	C4	184	183	U18	230
CONF_DONE (2)	A1	G3	160	161	M16	204
nWS	L4	P1	133	134	F18	167
nRS	K5	N1	137	138	G18	171
RDCLK	F1	G2	158	159	M17	202
nCS	D1	E2	166	167	N16	212
CS	C1	E3	169	170	N18	215
RDYnBUSY	J3	K2	146	147	J17	183
CLKUSR	G2	H2	155	156	K19	199
ADD17	M14	R15	58	56	E3	73
ADD16	L12	T17	56	54	E2	71
ADD15	M15	P15	54	52	F4	69
ADD14	L13	M14	47	45	G1	60
ADD13	L14	M15	45	43	H2	58
ADD12	K13	M16	43	41	H1	56
ADD11	K15	K15	36	34	J3	47
ADD10	J13	K17	34	32	К3	45
ADD9	J15	J14	32	30	K4	43
ADD8	G14	J15	29	27	L1	34
ADD7	G13	H17	27	25	L2	32
ADD6	G11	H15	25	23	M1	30
ADD5	F14	F16	18	16	N2	20
ADD4	E13	F15	16	14	N3	18
ADD3	D15	F14	14	12	N4	16
ADD2	D14	D15	7	5	U1	8
ADD1	E12	B17	5	3	U2	6
ADD0	C15	C15	3	1	V1	4
DATA7	A7	A7	205	199	W13	254
DATA6	D7	D8	203	197	W14	252
DATA5	A6	B7	200	196	W15	250

Pin Name	225-Pin BGA EPF8820A	232-Pin PGA EPF81188A	240-Pin PQFP EPF81188A	240-Pin PQFP EPF81500A	280-Pin PGA EPF81500A	304-Pin RQFP EPF81500A
DATA4	A5	C7	198	194	W16	248
data3	B5	D7	196	193	W17	246
DATA2	E6	B5	194	190	V16	243
DATA1	D5	A3	191	189	U16	241
DATA0	C4	A2	189	187	V17	239
SDOUT (3)	K1	N2	135	136	F19	169
TDI	F15 (4)	-	-	63 (14)	B1 (14)	80 (14)
TDO	J2 (4)	-	-	117	C17	149
тск <i>(6)</i>	J14 <i>(4)</i>	-	-	116 (14)	A19 (14)	148 (14)
TMS	J12 <i>(4)</i>	-	-	64 (14)	C2 (14)	81 (14)
TRST (7)	P14	-	-	115 (14)	A18 (14)	145 (14)
Dedicated Inputs (10)	F4, L1, K12, E15	C1, C17, R1, R17	10, 51, 130, 171	8, 49, 131, 172	F1, F16, P3, P19	12, 64, 164, 217
VCCINT (5.0 V)	F5, F10, E1, L2, K4, M12, P15, H13, H14, B15, C13	E4, H4, L4, P12, L14, H14, E14, R14, U1	20, 42, 64, 66, 114, 128, 150, 172, 236	18, 40, 60, 62, 91, 114, 129, 151, 173, 209, 236	E8, E10, E12,	24, 54, 77, 144, 79, 115, 162, 191, 218 266, 301
VCCIO (5.0 V or 3.3 V)	H3, H2, P6, R6, P10, N10, R14, N13, H15, H12, D12, A14, B10, A10, B6, C6, A2, C3, M4, R2	N10, M13, M5, K13, K5, H13, H5, F5, E10, E8, N8, F13	19, 41, 65, 81, 99, 116, 140, 162, 186, 202, 220, 235	17, 39, 61, 78, 94, 108, 130, 152, 174, 191, 205, 221, 235	D14, E7, E9, E11, E13, R6, R8, R10, R12, T13, T15	

Table 54. FLEX	Table 54. FLEX 8000 225-, 232-, 240-, 280- & 304-Pin Package Pin-Outs (Part 3 of 3)								
Pin Name	225-Pin BGA EPF8820A	232-Pin PGA EPF81188A	240-Pin PQFP EPF81188A	240-Pin PQFP EPF81500A	280-Pin PGA EPF81500A	304-Pin RQFP EPF81500A			
GND	B1, D4, E14, F7, F8, F9, F12, G6, G7, G8, G9, G10, H1, H4, H5, H6, H7, H8, H9, H10, H11, J6, J7, J8, J9, J10, K6, K7, K8, K9, K11, L15, N3, P1	K4, K14, L5, L13, N4, N7,	8, 9, 30, 31, 52, 53, 72, 90, 108, 115, 129, 139, 151, 161, 173, 185, 187, 193, 211, 229	6, 7, 28, 29, 50, 51, 71, 85, 92, 101, 118, 119, 140, 141, 162, 163, 184, 185, 186, 198, 208, 214, 228	D4, D5, D16, E4, E5, E6, E15, E16, F5, F15, G5, G15, H5, H15, J5, J15, K5, K15, L5, L15, M5, M15, N5, N15, P4, P5, P15, P16, R4, R5, R15, R16, T4, T5, T16, U17	151,175,177, 206,208,231, 232,237,253, 265,273,291			
No Connect (N.C.)		_	61, 62, 119, 120, 181, 182, 239, 240	-	_	10, 21, 23, 25, 35, 37, 39, 40, 41, 42, 52, 55, 66, 68, 146, 147, 161, 173, 174, 176, 187, 188, 189, 190, 192, 194, 195, 205, 207, 219, 221, 233, 234, 235, 236, 302, 303			
Total User I/O Pins <i>(9)</i>	148	180	180	177	204	204			